

About This Symposium

The "2014 International Symposium on Electromagnetic Compatibility" (EMC'14/Tokyo) will be held at "Hitotsubashi Hall (National Center of Sciences)", Chiyoda, Tokyo, from May 12 to 16, 2014. EMC'14/Tokyo is the 7th "International Symposium on Electromagnetic Compatibility" organized by "The Institute of Electronics, Information and Communication Engineers, Communications Society" (IEICE-CS). We would like to invite all engaged in research and development in the various fields of electromagnetic compatibility to participate in this Symposium. This EMC Symposium series has a long history and it has been held every 5 years, celebrating its 30th anniversary this time. The first of its series was held in Tokyo in 1984, which was chaired by Prof. Risaburo Sato (1911-2011). The design of broadcasting antennas for the Tokyo Tower was one of his great achievements in addition to memorable scientific contributions to EMC.

Prof. Masao Taki, EMC'14/Tokyo General Chair,

Prof. Osami Wada, EMC'14/Tokyo Technical Program Committee Chair

Symposium Schedule

• Registration Desk	May 12-16 (Mon-Fri)
• Technical Tour (optional)	May 12 (Mon)
• Technical Sessions	May 13-16 (Tue-Fri)
• Technical Exhibition	May 13-16 (Tue-Fri)
• Welcome Reception	May 13 (Tue)
• Banquet & Award Ceremony (optional)	May 15 (Thu)

Session Topics

- 1. EMC Measurements
- 2. High Power & High Voltage EMC
- 3. EMC Management and Standards
- 4. Chip, Package, PCB & Cables
- **5**. Immunity / Susceptibility, ESD and Transients
- 6. Shielding, Grounding & Materials
- 7. Numerical Modeling
- 8. EMF Safety & Biomedical Issues
- 9. Power System EMC
- **10**. Power Electronics & Vehicles
- 11. Communication System EMC

Registration Fees

- Pre-Registration for **Presenters** (from Nov. 30, 2013 to **Jan. 31**, 2014)
- Pre-Registration for Participants (from Nov. 30, 2013 to Apr. 20, 2014)

Regular 47,000 JPY

Student 25,000 JPY

• On-site Registration for Participants (from May 12 to 16, 2014)

Regular 57,000 JPY

Student 30,000 JPY

■ Sponsored by:

The Institute of Electronics, Information and Communication Engineers, Communications Society (IEICE-CS)

■ Technically Co-sponsored by:

IEEE EMC Society; Technical Committee on EMC of The Institute of Electrical Engineers of Japan (IEEJ TC-EMC)

■ Technically Co-operated by:

IEEE EMC-S Japan and Sendai Chapters; IEEE Tokyo Section; Asia-Pacific International Symposium on Electromagnetic Compatibility, Technical Program Committee (APEMC TPC); The Korean Institute of Electromagnetic Engineering and Science (KIEES), Technical Groups on "EMC Technology" and "EMF and Biology"; International Union of Radio Science (URSI); IEC, Technical Committee on Electromagnetic Compatibility (IEC/TC77); IEC, Technical Committee on Methods for the Assessment of Electric, Magnetic, and Electromagnetic Fields Associated with Human Exposure (IEC/TC106); International Special Committee on Radio Interference (CISPR); VCCI Council; The Japan Institute of Electronics Packaging (JIEP); The Japan Society of Applied Physics (JSAP); The Society of Instrument and Control Engineers (SICE); The Institute of Electrostatics Japan (IEJ); Japanese Society for Medical and Biological Engineering (JSMBE)

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